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AUTOMOTIVE

HALOGEN

FREE GREEN

High Speed Infrared Emitting Diodes, 890 nm, Surface Emitter Technology

VSMY2893RGX01 VSMY2893GX01





LINKS TO ADDITIONAL RESOURCES



DESCRIPTION

As part of the <u>SurfLight</u>TM portfolio, the VSMY2893 series are infrared, 890 nm emitting diodes based on GaAlAs surface emitter chip technology with extreme high radiant intensities, high optical power and high speed, molded in clear, untinted plastic packages (with lens) for surface mounting (SMD).

FEATURES

- · Package type: surface-mount
- · Package form: GW, RGW, side view
- Dimensions (L x W x H in mm): 2.3 x 2.3 x 2.55
- AEC-Q101 qualified
- Peak wavelength: $\lambda_p = 890 \text{ nm}$
- Angle of half intensity: $\varphi = \pm 28^{\circ}$
- Suitable for high pulse current operation
- Terminal configurations: gullwing or reverse gullwing
- Package matches with detector VEMD2503X01 series
- Floor life: 4 weeks, MSL 2a, according to J-STD-020
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

APPLICATIONS

- · Automotive sensors
- Optical switch
- · Emitter source for proximity sensors
- IR illumination
- Head-up displays

PRODUCT SUMMARY				
COMPONENT	I _e (mW/sr) at I _F = 100 mA	φ (°)	λ _P (nm)	t _r (ns)
VSMY2893RGX01	50	± 28	890	15
VSMY2893GX01	50	± 28	890	15
VSMY2893SLX01	50	± 28	890	15

Note

· Test conditions see table "Basic Characteristics"

ORDERING INFORMATION				
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM	
VSMY2893RGX01	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Reverse gullwing	
VSMY2893GX01	Tape and reel	MOQ: 6000 pcs, 6000 pcs/reel	Gullwing	
VSMY2893SLX01	Tape and reel	MOQ: 6000 pcs, 3000 pcs/reel	Side view	

Note

· MOQ: minimum order quantity

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ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Forward current		I _F	100	mA	
Peak forward current	$t_p/T = 0.5, t_p = 100 \mu s$	I _{FM}	200	mA	
Surge forward current	t _p = 100 μs	I _{FSM}	1	А	
Power dissipation		P _V	190	mW	
Junction temperature		Tj	100	°C	
Operating temperature range		T _{amb}	-40 to +85	°C	
Storage temperature range		T _{stg}	-40 to +100	°C	
Soldering temperature	According to Fig. 9, J-STD-020	T _{sd}	260	°C	
Thermal resistance junction-to-ambient	JESD51	R _{thJA}	250	K/W	

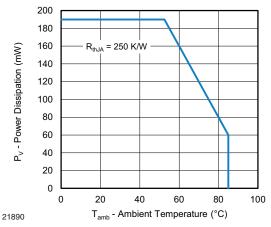


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

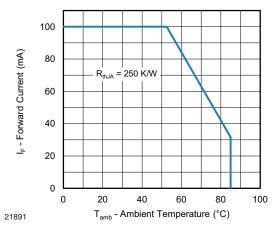


Fig. 2 - Forward Current Limit vs. Ambient Temperature

BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	V_{F}	-	1.6	1.9	V
	$I_F = 1 \text{ A}, t_p = 100 \ \mu\text{s}$	V _F	-	2.8	-	V
Temperature coefficient of V _F	I _F = 100 mA	TK _{VF}	-	-2.0	-	mV/K
Reverse current		I _R	Not designed for reverse operation		μA	
Junction capacitance	$V_R = 0 \text{ V}, f = 1 \text{ MHz}, E = 0 \text{ mW/cm}^2$	CJ	-	60	-	pF
Radiant intensity	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	l _e	27	50	75	mW/sr
nation intensity	$I_F = 1 \text{ A}, t_p = 100 \ \mu \text{s}$	l _e	-	350	-	mW/sr
Radiant power	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	фe	-	55	-	mW
Temperature coefficient of radiant power	I _F = 100 mA	TKφ _e	-	-0.15	-	%/K
Angle of half intensity		φ	-	± 28	-	0
Peak wavelength	I _F = 100 mA	λ_{p}	870	890	910	nm
Spectral bandwidth	I _F = 100 mA	Δλ	-	35	-	nm
Temperature coefficient of λ _p	I _F = 100 mA	TKλ _p	-	0.3	-	nm/K
Rise time	I _F = 100 mA, 10 % to 90 %	t _r	-	15	-	ns
Fall time	I _F = 100 mA, 10 % to 90 %	t _f	-	15	-	ns

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BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

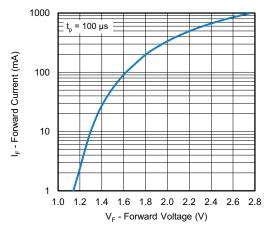


Fig. 3 - Forward Current vs. Forward Voltage

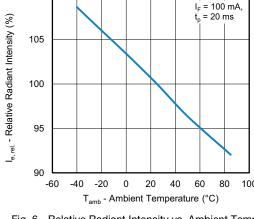


Fig. 6 - Relative Radiant Intensity vs. Ambient Temperature

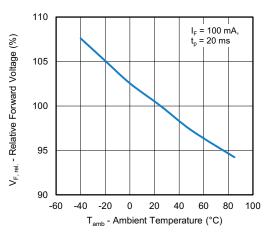


Fig. 4 - Relative Forward Voltage vs. Ambient Temperature

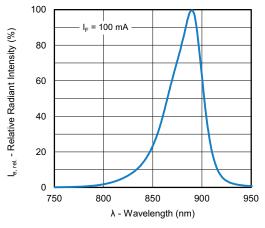


Fig. 7 - Relative Radiant Intensity vs. Wavelength

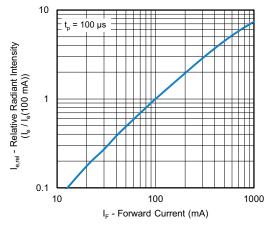


Fig. 5 - Relative Radiant Intensity vs. Forward Current

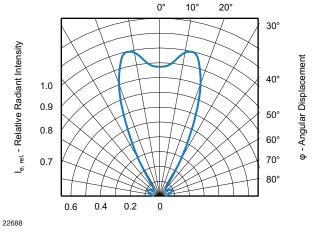


Fig. 8 - Relative Radiant Intensity vs. Angular Displacement



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SOLDER PROFILE

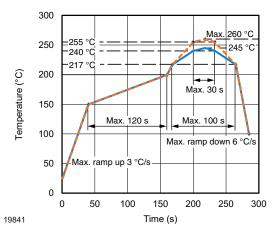


Fig. 9 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 4 weeks

Conditions: T_{amb} < 30 °C, RH < 60 %

Moisture sensitivity level 2a, according to J-STD-020.

DRYING

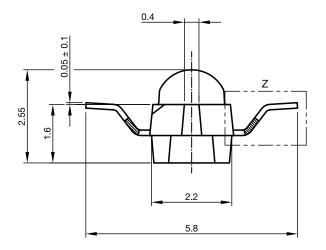
In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-033D or label. Devices taped on reel dry using recommended conditions 192 h at 40 $^{\circ}$ C (+ 5 $^{\circ}$ C), RH < 5 $^{\circ}$ M.

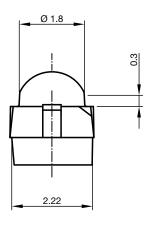


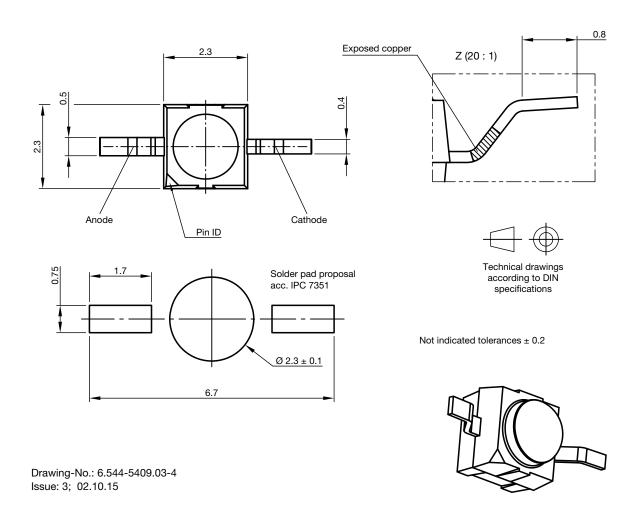
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PACKAGE DIMENSIONS in millimeters: VSMY2893RGX01



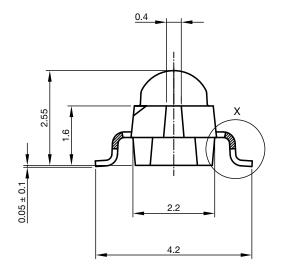


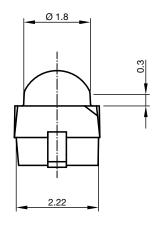


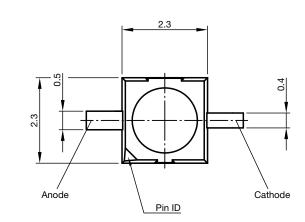
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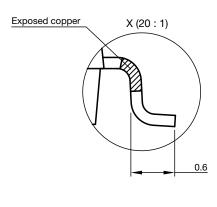
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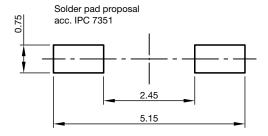
PACKAGE DIMENSIONS in millimeters: VSMY2893GX01





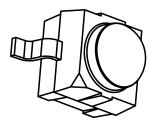








Not indicated tolerances ± 0.2



Drawing-No.: 6.544-5408.03-4

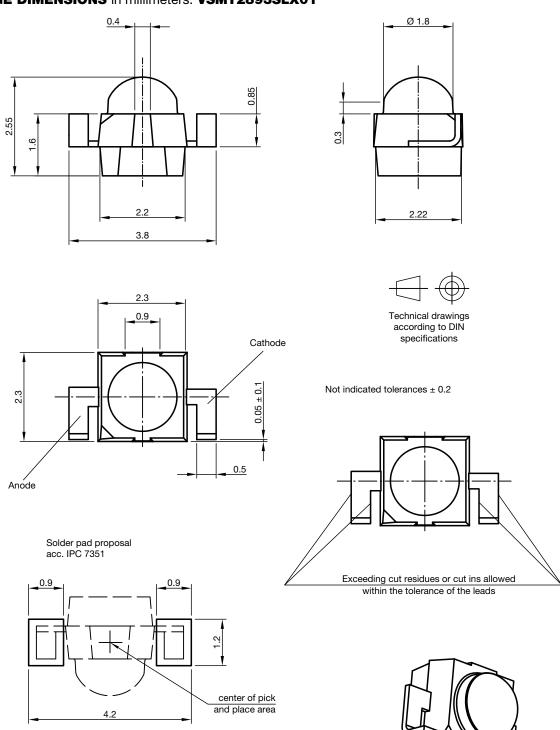
Issue: 3; 02.10.15



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PACKAGE DIMENSIONS in millimeters: VSMY2893SLX01



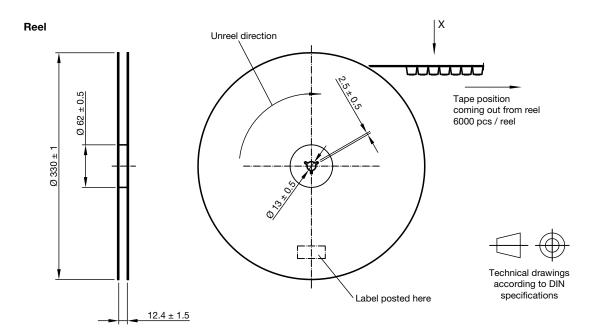
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Issue: 3; 02.10.15

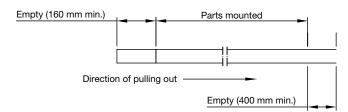
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TAPING AND REEL DIMENSIONS in millimeters: VSMY2893RGX01



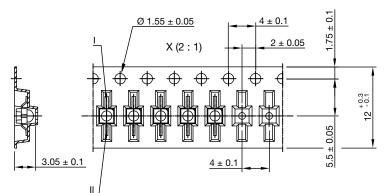
Leader and trailer tape



Terminal position in tape

Device	Lead I	Lead II	
VSMB2943RGX01			
VSMF2893RGX01	Cathode	Anode	
VEMD2x03X01			
VEMT2x03X01	Collector	Emitter	
VSMY2xxx	Anode	Cathode	

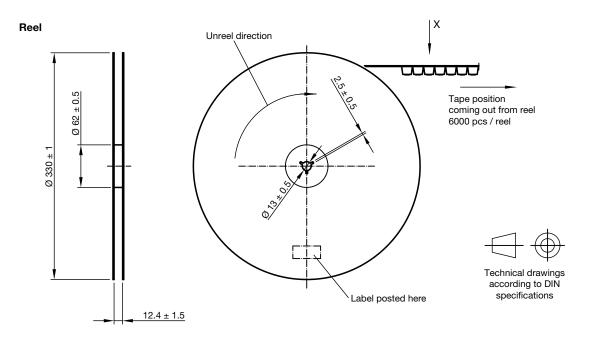
Drawing-No.: 9.800-5100.02-4 Issue: prel.; 11.07.19



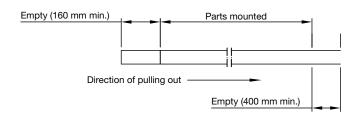
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TAPING AND REEL DIMENSIONS in millimeters: VSMY2893GX01

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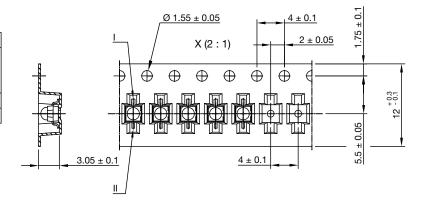
Leader and trailer tape



Terminal position in tape

Device	Lead I	Lead II
VSMB2943GX01		
VSMF2893GX01	Cathode	Anode
VEMD2x23X01		
VEMT2x23X01	Collector	Emitter
VSMY2xxx	Anode	Cathode

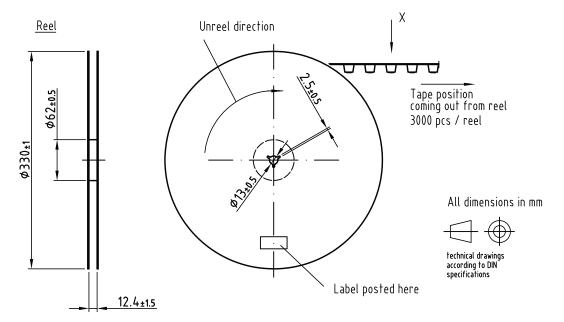
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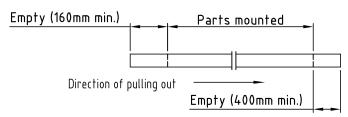
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TAPING AND REEL DIMENSIONS in millimeters: VSMY2893SLX01

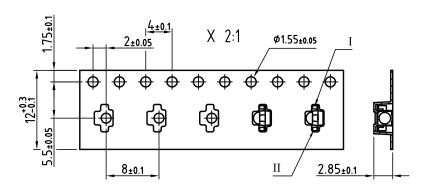


Leader and trailer tape:



Terminal position in tape

Device	Lead I	Lead II
VSMB2943SLX01		
VSMF2893SLX01	C.44.4.	
VSMB2948SL	Cathode	Anode
VEMD2023SLX01		
VEMD2523SLX01		
VEMT2023SLX01	Collector	Emitter
VEMT2523SLX01	Collector	Emitter
VSMY2xxx		
	Anode	Cathode



Drawing refers to following types: see table Reel dimensions and tape

Drawing-No.: 9.800-5123.01-4 Issue: preliminary, 11.07.19



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